221. Install label in silenced box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PIP schematic.

222. These assemblies are ESD sensitive, ESD precautions shall be observed.

223. These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

224. These assemblies must comply with workmanship standards IPC-T-650 Class 2, unless otherwise specified.

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**Diagram Notes:**

- **COMPONENT NAME:** PAB T
- **COMPONENT VALUE:** COB T
- **COMPONENT VALUE:** COBUZZ
- **COMPONENT VALUE:** COBUZZER
- **COMPONENT VALUE:** PAC1
- **COMPONENT VALUE:** PAC2
- **COMPONENT VALUE:** PAC3
- **COMPONENT VALUE:** PAC4
- **COMPONENT VALUE:** PAC5
- **COMPONENT VALUE:** PAC6
- **COMPONENT VALUE:** PAC7
- **COMPONENT VALUE:** PAC8
- **COMPONENT VALUE:** PAC9
- **COMPONENT VALUE:** PAC31
- **COMPONENT VALUE:** PACURRENT
- **COMPONENT VALUE:** PAD0
- **COMPONENT VALUE:** PAD1
- **COMPONENT VALUE:** PAD2
- **COMPONENT VALUE:** PALEAK
- **COMPONENT VALUE:** PALEFT
- **COMPONENT VALUE:** PAPOW
- **COMPONENT VALUE:** PAQ1
- **COMPONENT VALUE:** PAQ2
- **COMPONENT VALUE:** PAQ3
- **COMPONENT VALUE:** PAR1
- **COMPONENT VALUE:** PAR2
- **COMPONENT VALUE:** PAR3
- **COMPONENT VALUE:** PAR4
- **COMPONENT VALUE:** PAR5
- **COMPONENT VALUE:** PAR6
- **COMPONENT VALUE:** PAR7
- **COMPONENT VALUE:** PAR8
- **COMPONENT VALUE:** PAR9
- **COMPONENT VALUE:** PARIGHT
- **COMPONENT VALUE:** PASCL
- **COMPONENT VALUE:** PASDA
- **COMPONENT VALUE:** PASH0J1
- **COMPONENT VALUE:** PASH0J2
- **COMPONENT VALUE:** PASH0J3
- **COMPONENT VALUE:** PASH0J4
- **COMPONENT VALUE:** PAU1
- **COMPONENT VALUE:** PAWater
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